LN21RPX

Round Type

 ϕ 5.0 mm

■ Absolute Maximum Ratings $T_a = 25$ °C

| Parameter | Symbol | Rating | Unit | |
|-------------------------------|------------------|-------------|------|--|
| Power dissipation | P_{D} | 70 | mW | |
| Forward current | I_{F} | 25 | mA | |
| Pulse forward current * | I_{FP} | 150 | mA | |
| Reverse voltage | V _R | 4 | V | |
| Operating ambient temperature | T _{opr} | -25 to +85 | °C | |
| Storage temperature | T _{stg} | -30 to +100 | °C | |

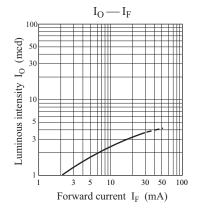
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

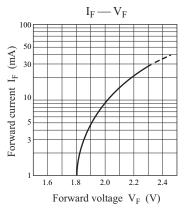
■ Lighting Color

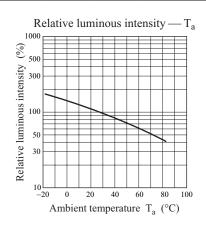
Red

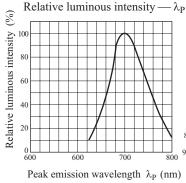
■ Electro-Optical Characteristics $T_a = 25$ °C

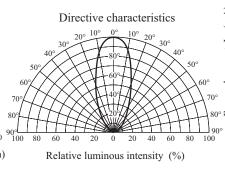
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--------------------------|------------------------|-----------------------|-----|-----|-----|------|
| Luminous intensity | I _O | | 1.5 | 4.0 | | mcd |
| Reverse current | I_R | $V_R = 4 V$ | | | 5 | μΑ |
| Forward voltage | V_{F} | $I_F = 20 \text{ mA}$ | | 2.2 | 2.8 | V |
| Peak emission wavelength | λ_{P} | $I_F = 20 \text{ mA}$ | | 700 | | nm |
| Spectral half band width | Δλ | $I_F = 20 \text{ mA}$ | | 100 | | nm |

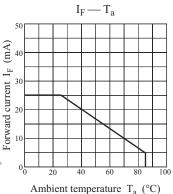






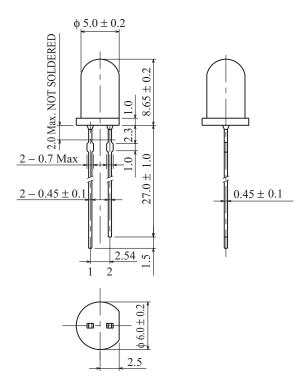






■ Package (Unit: mm)

LLXLTN2SK010



- Pin name
 - 1: Anode
 - 2: Cathode

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